onsemi  Contact Name  Title - Contact  Phone - Contact*  Email - Contact*  Product-Env-Stewards  Authorized Representative*  Product Enviro Compliance  NA  Product-Env-Stewards@onsemi.com  Phone - Representative*  Email - Representative*		Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
Company name* Company unique ID  Unique ID Authority  Response Date* 2025-05-07  Contact Name  Title - Contact  Phone - Contact*  Product Env-Stewards  Product Enviro Compliance  Inthorized Representative*  Product Enviro Compliance  NA  Product Env-Stewards @onsemi.com  Product Enviro Compliance  NA  Product Env-Stewards @onsemi.com  NA  Product Env-Stewards @onsemi.com  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  Manufacturing Proccess Information  Manufacturing Proccess Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  J-STD-020 MSL Rating  Peak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cycles  Matte Tin (Sn) - annealed  CU Alloy  NA  0  C  30  Seconds  3										ous Material	rials and Mfg Information				
Insemi In	plier Informa	ntion													
Title - Contact* Product-Env-Stewards Product-Env-S	Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
Product-Env-Stewards Uthorized Representative* Title - Representative Product-Env-Stewards Product-Env-Stewards@onsemi.com Manufacturing Site Weight* UOM  MC7805ABTG ANA 1A 5V VREG 2025-05-07 CNC 1365.61 mg  Manufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy D-STD-020 MSL Rating Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3	onsemi											2025-05-07			
Title - Representative Product Enviro Compliance NA Product-Env-Stewards Onsemi.com Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM  MC7805ABTG ANA 1A 5V VREG 2025-05-07 CNC 1365.61 mg  Manufacturing Process Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Mate Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3	Contact Name				Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  MC7805ABTG  ANA 1A 5V VREG  2025-05-07  CNC  1365.61  mg  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  Matte Tin (Sn) - annealed  CU Alloy  NA  Product-Env-Stewards@onsemi.com  Manufacturing Site  Weight*  UOM  Product-Env-Stewards@onsemi.com  Manufacturing Site  Weight*  Womber of Reflow Cyclester  Number of Reflow Cyclester  Number of Reflow Cyclester  Number of Reflow Cyclester  Na  O  C  30  Seconds  3	Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Authorized Representative*			Title - Representative			I	Phone - Representative*				Email - Representative*			
MC7805ABTG ANA 1A 5V VREG 2025-05-07 CNC 1365.61 mg    Institution   Ins	Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Terminal Plating / Grid Array Material   Terminal Base Alloy   J-STD-020 MSL Rating   Peak Process Body Temperature   Max Time at Peak Temperature   Number of Reflow Cycles   Matte Tin (Sn) - annealed   CU Alloy   NA   0   C   30     seconds   3	Requester I	Requester Item Number Mfr Item						Effective Date	Version	Manufacturir	ng Site	Weight*	UOM	Unit Type	
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omments		(Sn) - annealed	C	CU Alloy	Ι.	NA		Į U	IC.	30		seconds 3			
	nents														
or more information regarding material composition please refer to page 3			•.•												

RoHS Material Composition Declaration			Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belie as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applica									
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature Ra	astislav Drska	-En							

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.61	mg	Supplier	Silicon (Si)	7440-21-3		1.61	mg
Die Attach	0.21	mg	A	Lead (Pb)	7439-92-1	7a	0.189	mg
			Supplier	Tin (Sn)	7440-31-5		0.021	mg
Lead Frame	677.24		Supplier	Silver (Ag)	7440-22-4		0.0339	mg
			Supplier	Iron (Fe)	7439-89-6		0.6772	mg
			Supplier	Copper (Cu)	7440-50-8		676.3054	mg
			Supplier	Phosphorus (P)	7723-14-0		0.2235	mg
Mold Compound-Black	644.0	mg		Metal Hydroxide	proprietary data		30.268	mg
			Supplier	Carbon Black (C)	1333-86-4		1.932	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		515.2	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		64.4	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		32.1999	mg
Plating	42.4	mg	Supplier	Tin (Sn)	7440-31-5		42.4	mg
Wire Bond - Cu	0.15	mg	Supplier	Copper (Cu)	7440-50-8		0.15	mg